# Vishay Siliconix



<b>SPECIFICATIONS</b> $T_J = 25  ^{\circ}C$ , Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	Cymbol	rest conditions		1,75.	WIUX.	Oint
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 19		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			4.4		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = -250 \mu A$	- 1.2		- 2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V			- 1	μΑ
		V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 5	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 25			Α
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 4.2 A		0.037	0.045	Ω
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.2 A		0.062	0.075	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 4.2 A		10		S
Dynamic <sup>b</sup>				•	•	
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		590		pF
Output Capacitance	C <sub>oss</sub>			115		
Reverse Transfer Capacitance	C <sub>rss</sub>	]		93		
Total Gate Charge	$Q_{g}$	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 4.2 A		13.6	21	nC
Total Gate Charge	ŭ	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.2 A		7	11	
Gate-Source Charge	$Q_{gs}$			2.3		
Gate-Drain Charge	$Q_{gd}$			3.2		
Gate Resistance	$R_g$	f = 1 MHz	1	5	10	Ω
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = - 15 V, $R_L$ = 4.5 $\Omega$ $I_D$ $\cong$ - 3.3 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		30	45	ns
Rise Time	t <sub>r</sub>			25	38	
Turn-Off Delay Time	t <sub>d(off)</sub>			16	24	
Fall Time	t <sub>f</sub>			8	16	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = - 15 V, $R_L$ = 4.5 $\Omega$ $I_D$ $\cong$ - 3.3 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		8	16	
Rise Time	t <sub>r</sub>			10	20	
Turn-Off Delay Time	t <sub>d(off)</sub>			18	27	
Fall Time	t <sub>f</sub>			8	16	
Drain-Source Body Diode Characteristi	cs			•	•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.2	A
Pulse Diode Forward Current	I <sub>SM</sub>				- 25	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 3.3 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = -3.3 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		17	26	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			9	18	nC
Reverse Recovery Fall Time	t <sub>a</sub>			10		ns
Reverse Recovery Rise Time	t <sub>b</sub>			7		

#### Notes:

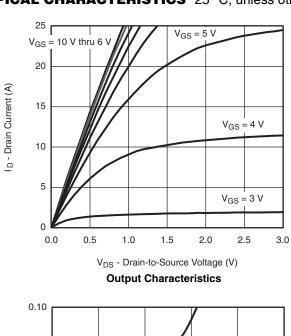
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

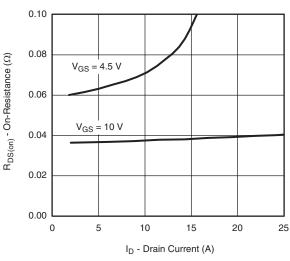
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

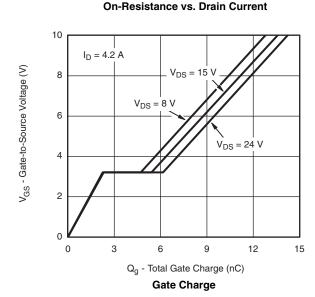


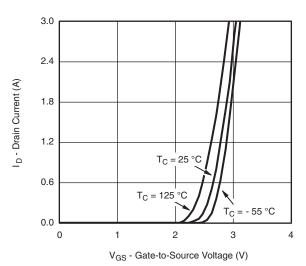


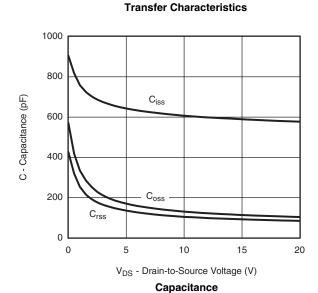
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

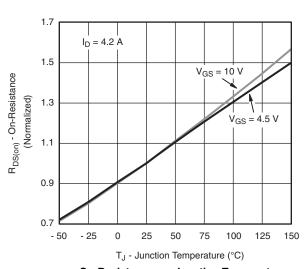










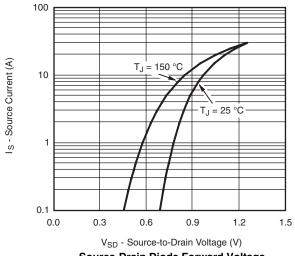


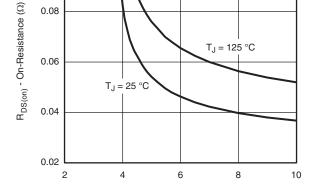
On-Resistance vs. Junction Temperature

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 $I_D = 4.2 A$ 

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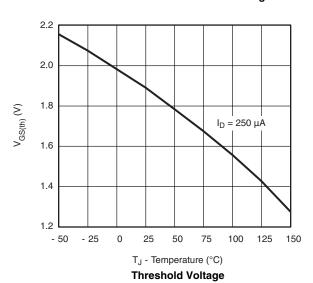


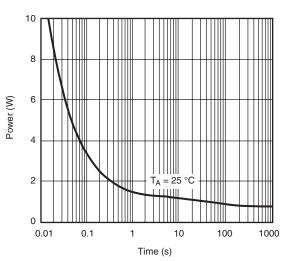


0.10

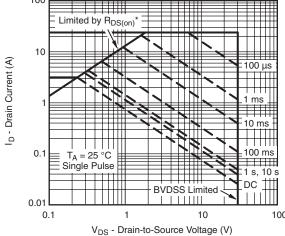
Source-Drain Diode Forward Voltage

V<sub>GS</sub> - Gate-to-Source Voltage (V) On-Resistance vs. Gate-to-Source Voltage





Single Pulse Power (Junction-to-Ambient)

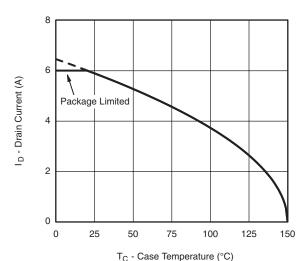


\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

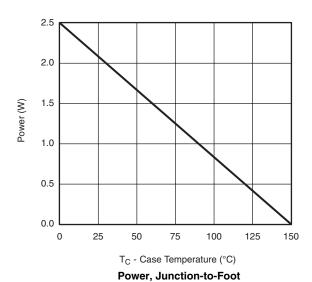


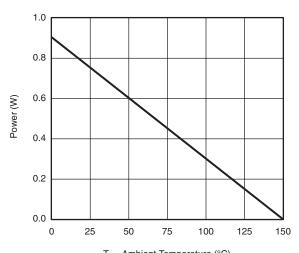
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



C - Case Temperature (\*C)

#### **Current Derating\***





T<sub>A</sub> - Ambient Temperature (°C)

Power, Junction-to-Ambient

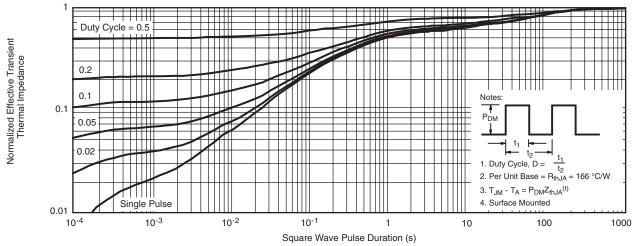
Document Number: 65474 S09-2270-Rev. A, 02-Nov-09

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

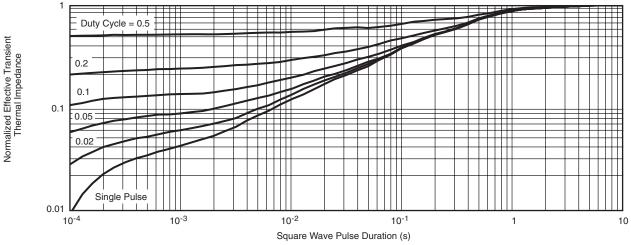
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppq?65474">www.vishay.com/ppq?65474</a>.



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